



### **DUAL N-CHANNEL ENHANCEMENT MODE MOSFET**

### **Product Summary**

BV <sub>DSS</sub>	Rds(on) (MAX)	I <sub>D (MAX)</sub> T <sub>A</sub> = +25°C
30V	190mΩ @ V <sub>GS</sub> = 10V	1A
307	$335m\Omega$ @ $V_{GS} = 4.5V$	0.75A

## **Description and Applications**

This MOSFET is designed to meet the stringent requirements of automotive applications. It is qualified to AEC-Q101, supported by a PPAP and is ideal for use in:

- Motor Control
- DC-DC Converters
- Load Switch

## **Features and Benefits**

- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- ESD Protected Gate
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

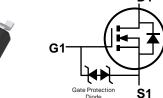
### **Mechanical Data**

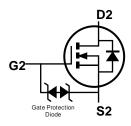
- Case: SOT363
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish Matte Tin Annealed over Alloy 42 Leadframe.
   Solderable per MIL-STD-202, Method 208 (a)
- Weight: 0.006 grams (Approximate)

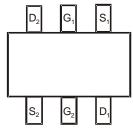




Top View







Q1 N-Channel

Q2 N-Channel

Top View Pin Out

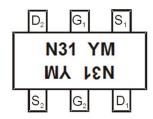
### **Ordering Information (Note 5)**

Part Number	Case	Packaging
DMN3190LDWQ-7	SOT363	3000/Tape & Reel
DMN3190LDWQ-13	SOT363	10000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Refer to https://www.diodes.com/quality/.
- 5. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/

## **Marking Information**



N31 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: F = 2018) M = Month (ex: 9 = September)

### Date Code Key

Year	201	8	2019		2020	20	21	2022		2023	2	2024
Code	F		G		Н			J		K		L
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



# **Maximum Ratings** ( $@T_A = +25^{\circ}C$ , unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Drain-Source Voltage		V <sub>DSS</sub>	30	V	
Gate-Source Voltage		$V_{GSS}$	±20	V	
Continuous Drain Current (Note 7) V <sub>GS</sub> = 10V	Steady State	$T_A = +25$ °C $T_A = +70$ °C	I <sub>D</sub>	1000 900	mA
Continuous Diam Current (Note 7) VGS = 10V	t < 5s	$T_A = +25$ °C $T_A = +70$ °C	l <sub>D</sub>	1300 1000	mA
Maximum Continuous Body Diode Forward Current	(Note 6)	I <sub>S</sub>	0.5	Α	
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%	<u>6</u> )	I <sub>DM</sub>	2.0	Α	

# Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 6)	T <sub>A</sub> = +25°C	P <sub>D</sub>	0.32	W
Total Fower Dissipation (Note 6)	$T_A = +70^{\circ}C$	FD	0.19	VV
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	ReJA	395	°C/W
Thermal Resistance, Junction to Ambient (Note o)	t < 5s	Көја	320	0/44
Total Power Dissipation (Note 7)	$T_A = +25^{\circ}C$	PD	0.4	W
Total Fower Dissipation (Note 1)	$T_A = +70^{\circ}C$	PD	0.25	VV
Thermal Resistance, Junction to Ambient (Note 7)	Steady State	D	320	
Thermal Resistance, Junction to Ambient (Note 1)	t < 5s	$R_{\theta JA}$	250	°C/W
Thermal Resistance, Junction to Case		$R_{ heta JC}$	143	
Operating and Storage Temperature Range		T <sub>J,</sub> T <sub>STG</sub>	-55 to +150	°C

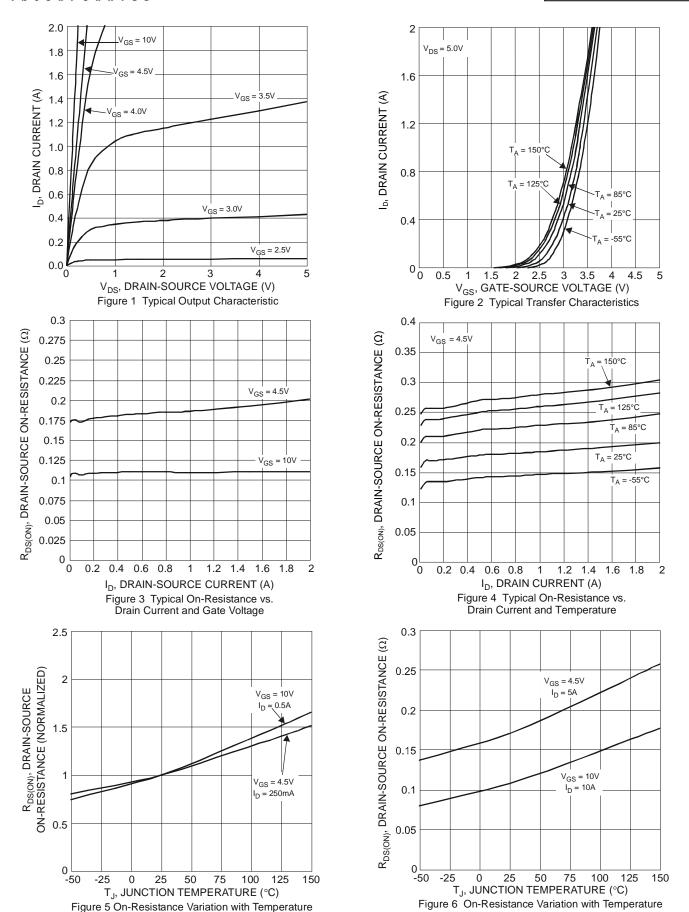
# **Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	30	_	_	V	$V_{GS} = 0V$ , $I_D = 1mA$	
Zero Gate Voltage Drain Current @T <sub>C</sub> = +25	°C I <sub>DSS</sub>	_	_	1	μA	$V_{DS} = 30V$ , $V_{GS} = 0V$	
Gate-Source Leakage	I <sub>GSS</sub>	_	_	±10	μΑ	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)							
Gate Threshold Voltage	V <sub>GS(TH)</sub>	1.5	_	2.8	V	$V_{DS} = V_{GS}$ , $I_D = 250\mu A$	
Static Drain-Source On-Resistance		_	122	190	mΩ	$V_{GS} = 10V, I_D = 1.3A$	
Static Dialif-Source Off-Resistance	R <sub>DS(ON)</sub>	_	181	335	11122	$V_{GS} = 4.5V, I_D = 290mA$	
Forward Transfer Admittance	Y <sub>fs</sub>	_	0.7	_	mS	$V_{DS} = 10V, I_D = 250mA$	
Diode Forward Voltage	V <sub>SD</sub>	_	_	1.2	V	$V_{GS} = 0V, I_{S} = 250mA$	
DYNAMIC CHARACTERISTICS (Note 9)							
Input Capacitance	C <sub>iss</sub>	_	87	_	pF	.,	
Output Capacitance		_	17	_	pF	$V_{DS} = 20V, V_{GS} = 0V,$ - f = 1.0MHz	
Reverse Transfer Capacitance	C <sub>rss</sub>	_	12	_	pF	1 = 1.01/11/12	
Gate Resistance	Rg	_	69.8	_	Ω	$f = 1MHz$ , $V_{GS} = 0V$ , $V_{DS} = 0V$	
Total Gate Charge (V <sub>GS</sub> = 4.5V)	Qg	_	0.9	_	nC		
Total Gate Charge (V <sub>GS</sub> = 10V)	Qg	_	2.0	_	nC	\/ 40\/   050m A	
Gate-Source Charge		_	0.3	_	nC	$V_{DS} = 10V, I_{D} = 250mA$	
Gate-Drain Charge		_	0.3	_	nC		
Turn-On Delay Time		_	4.5	_	ns		
Turn-On Rise Time		_	8.9	_	ns	$V_{DD} = 30V, V_{GS} = 10V,$	
Turn-Off Delay Time		_	30.3	_	ns	$R_G = 10\Omega, I_D = 100 \text{mA}$	
Turn-Off Fall Time		_	15.6	_	ns	7	

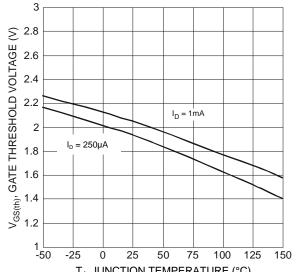
Notes: 6. Device mounted on FR-4 PCB, with minimum recommended pad layout.

- 7. Device mounted on 1" x 1" FR-4 PCB with high coverage 2oz. Copper, single sided.
- 8. Short duration pulse test used to minimize self-heating effect.
- 9. Guaranteed by design. Not subject to product testing.

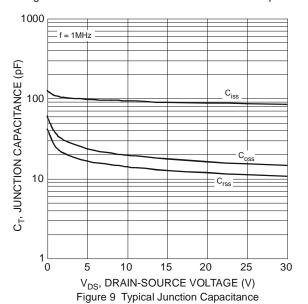


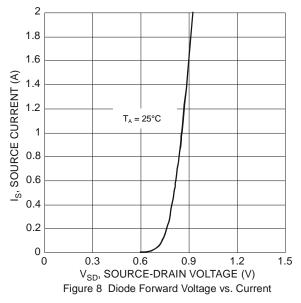


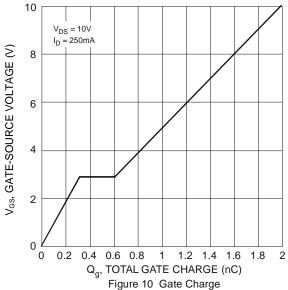




 $T_{\rm J},$  JUNCTION TEMPERATURE (°C) Figure 7 Gate Threshold Variation vs. Junction Temperature





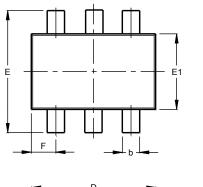


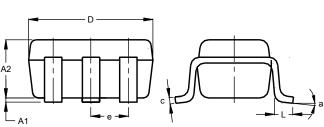


## **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

### **SOT363**



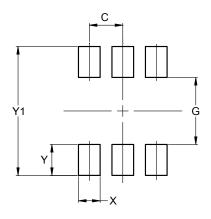


SOT363							
Dim	Min	Max	Тур				
A1	0.00	0.10	0.05				
A2	0.90	1.00	0.95				
b	0.10	0.30	0.25				
С	0.10	0.22	0.11				
D	1.80	2.20	2.15				
Е	2.00	2.20	2.10				
E1	1.15	1.35	1.30				
е	0.650 BSC						
F	0.40	0.45	0.425				
J	0.25	0.40	0.30				
а	0°	8°					
All Dimensions in mm							

## **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

### **SOT363**



Dimensions	Value
Dillielisions	(in mm)
С	0.650
G	1.300
Х	0.420
Y	0.600
Y1	2.500



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